Docket No.: LEE-0065

(MeV. 03-01)	RM COVER SHEET U.S. DEPARTMENT OF COMMERCE	
OMB No. 0851-0027 (exp.5/31/2002) Patent and Trademark Office POSA/REVO3 PATENTS ONLY		
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To the Director of the United States Patent and Trademark Off	ice: Please record the attached original documents or copy thereof.	
 Name of conveying party(les): Sang Young LE; Seok Koo KIM; Jung Don SUK; Hyun Hang YONG; Jang Hyuk HONG; Soon Ho AHN; Yong Ku KANG; Changjin LEE 	Name and address of receiving party(les): Name: LG CHEM, LTD. Address: 20, Yoido-Dong, Youngdungpo-gu	
Additional names(s) of conveying party(les)		
3. Nature of conveyance:		
⊠ Assignment ☐ Merger		
☐ Security Agreement ☐ Change of Name	City: Seoul State/Prov.:	
☐ Other	Country: Republic of Korea ZIP: 150-721	
Execution Date: May 22, 2006; June 15, 2006	Additional name(s) & address(es)	
4. Application number(s) or patent numbers(s):		
If this document is being filed together with a new application, t	the execution date of the application is:	
Patent Application No. Filing date	B. Patent No.(s)	
11/406,938 April 19, 2006		
Additional numbers 5. Name and address of party to whom correspondence concerning document should be mailed:	☐ Yea ☑ No 6. Total number of applications and patents Involved:	
Name: Jac Y. Park	7. Total fee (37 CFR 3.41):\$ 40,00	
Registration No. Limited Recognition No.: L0077 Address: Cantor Colburn LLP	☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account	
55 Griffin Road South	Authorized to be charged to deposit account	
	8. Deposit account number:	
City: Bloomfield State/Prov.: CT	06-1130	
Country: USA ZIP: 06002	(Attach duplicate copy of this page if paying by deposit account)	
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of the original document.	netion is true and correct and any attached copy is a true copy	
Name of Person Signing	Signature June 27, 2006 Date	
	ver sheet, attachments, and document:	

Additional name(s) & address(es) □Yes ⊠No

Item No. 2, Continued:

RECORDATION FORM COVER SHEET PATENTS ONLY

2. Name and address of receiving party(ies):

Name: KOREA RESEARCH INSTITUTE OF CHEMICAL TECHNOLOGY.

Address: 100. Jang-dong, Yuseong-gu Daejeon

City: _____ State/Prov: _____

Country: REPUBLIC OF KOREA ZIP: 305-343

PATENT REEL: 017868 FRAME: 0172

<u>ASSIGNMENT</u>

WHEREAS We, Sang Young LEE of 103-904, Expo Apartment, Jeonmin-dong, Yuseong-gu, Daejeon 305-761, Republic of Korea, Seok Koo KIM of 211-1203, Expo Apartment, Jeonmin-dong, Yuseong-gu, Daejeon 305-761, Republic of Korea, Jung Don SUK of 101-1504, Han bit Apartment, Eoeun-dong, Yuseong-gu, Daejeon 305-333, Republic of Korea, Hyun Hang YONG of 145-113, Oryu2-dong, Guro-gu, Seoul 152-102, Republic of Korea, Jang Hyuk HONG of 105-606, Gukhwa Apartment, 991, Samcheon-dong, Seo-gu, Daejeon 302-782, Republic of Korea, Soon Ho AHN of 109-1004, Samsung Hanwool Apartment, Shinsung-dong, Yuseong-gu, Daejeon 305-345, Republic of Korea, Yongku Kang of 109-701, Hanwool Apartment, Shinsung-dong, Yuseong-gu, Daejeon 305-345, Republic of Korea, and Changjin Lee of 510-1103, Expo Apartment, Jeonmin-dong, Yuseong-gu, Daejeon 305-761, Republic of Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improve ments in:

[SAFETY-IMPROVED ELECTRODE BY INTRODUCING CROSSLINKABLE POLYMER ANDELECTROCHEMICAL DEVICE COMPRISING THE SAME]

which claims priority to Korean Patent Application No. 10-2005-32433, filed 19/04/2005; and for which We are about to file or have filed an application for Letters Patent of the United States; Application Serial No. 11/406.938, filed 19/04/2006;

AND WHERBAS, LG CHEM, LTD., a corporation organized and existing under the laws of the Republic of Korea, having a place of business at 20, Yoido-dong, Youngdungpo-gu, Seoul 150-721, Republic of Korea and Korea Research Institute of Chemical Technology a corporation organized and existing under the laws of the Republic of Korea, having a place of business at 100, Jang-dong, Yuseong-gu Daejeon, 305-343 Republic of Korea are desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE S, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEES, an assignces of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEES, its successors and assigns; and We do hereby agree that the

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PATENT REEL: 017868 FRAME: 0173 said ASSIGNEES, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEES, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEES fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: June 15, 2006	Mee	L.S
Date: June 15, 2006	[Sang Young LEE]	L.S
Date: June 15, 2046	[Seok Koo KIM] [Jung Don SUK]	L.S
Date: June 15, 2006	[Hyun Hang YONG]	L.S
Date: June 15,2006	[Jang Hyuk HONG]	L. S .
Date: Tune 15,2006	[Soon Ho AHN]	L.S.
Date: May 22, 2006	Monghu Kang	L.S.
Date: May re, 2008	[Changlin Leel	L.S.

RECORDED: 06/27/2006